



## **Hex Half-bridge Driver with Serial Input Control**

#### DATASHEET

#### **Features**

- Six half-bridge outputs formed by six high-side and six low-side drivers
- Capable of switching all kinds of loads (such as DC motors, bulbs, resistors, capacitors and inductors)
- $R_{DSon}$  typically 1.0 $\Omega$  at 25°C, maximum 1.8 $\Omega$  at 150°C
- Up to 950-mA output current
- Very low total quiescent current I<sub>S</sub> < 2μA in standby mode</li>
- Outputs short-circuit protected
- Overtemperature prewarning and protection
- Undervoltage protection
- Various diagnosis functions such as shorted output, open load, overtemperature and power supply fail
- Serial data interface
- Operation voltage up to 40V
- Daisy chaining possible
- Serial interface 5V compatible, up to 2MHz clock frequency
- QFN24 5mm x 5mm power package

## 1. Description

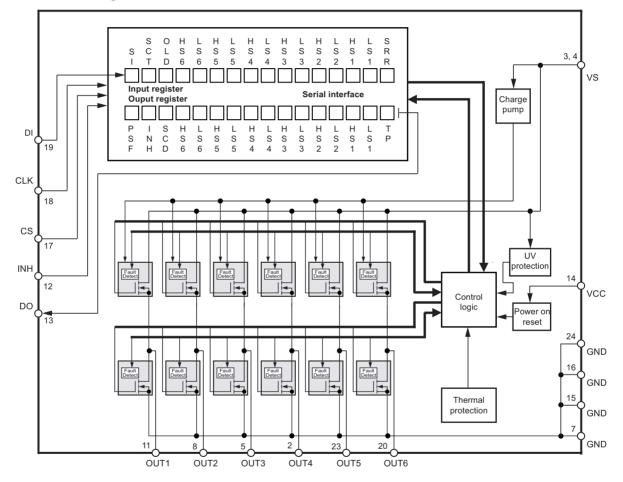
The Atmel® ATA6838C is a fully protected hex half-bridge driver designed in Smart Power SOI technology, used to control up to six different loads by a microcontroller in automotive and industrial applications.

Each of the six high-side and six low-side drivers is capable of driving currents up to 950mA. The drivers are internally connected to form six half-bridges and can be controlled separately from a standard serial data interface. Therefore, all kinds of loads, such as bulbs, resistors, capacitors and inductors, can be combined. The IC especially supports the application of H-bridges to drive DC motors.

Protection is guaranteed in terms of short-circuit conditions, overtemperature and undervoltage. Various diagnosis functions and a very low guiescent current in standby mode make a wide range of applications possible.

Automotive qualification referring to conducted interferences, EMC protection and ESD protection gives added value and enhanced quality for the exacting requirements of automotive applications.

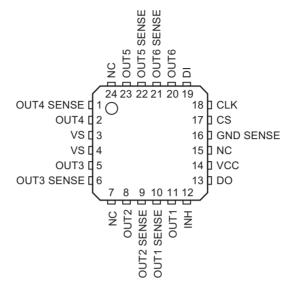
Figure 1-1. Block Diagram QFN24



## 2. Pin Configuration

### 2.1 QFN24

Figure 2-1. Pinning QFN 24,  $5 \times 5$ , 0.65mm Pitch



Note: YWW Date code (Y = Year above 2000, WW = week number)

ATAxyz Product name ZZZZZ Wafer lot number

AL Assembly sub-lot number

Table 2-1. Pin Description QFN24

Pin	Symbol	Function
1	OUT4 SENSE	Only for testability in final test
2	OUT4	Half-bridge output 4; formed by internally connected power MOS high-side switch 4 and low-side switch 4 with internal reverse diodes; short circuit protection; overtemperature protection; diagnosis for short and open load
3	VS	Power supply output stages HS4, HS5 and HS6
4	VS	Power supply output stages HS1, HS2 and HS3
5	OUT3	Output 3; see pin 1
6	OUT3 SENSE	Only for testability in final test
7	NC	Internal bond to GND
8	OUT2	Output 2; see pin 1
9	OUT2 SENSE	Only for testability in final test
10	OUT1 SENSE	Only for testability in final test
11	OUT1	Output 1; see pin 1
12	INH	Inhibit input; 5V logic input with internal pull down; low = standby, high = normal operation



Table 2-1. Pin Description QFN24 (Continued)

Pin	Symbol	Function
13	DO	Serial data output; 5V CMOS logic level tri-state output for output (status) register data; sends 16-bit status information to the microcontroller (LSB is transferred first). Output will remain tri-stated unless device is selected by CS = low, therefore, several ICs can operate on one data output line only
14	VCC	Logic supply voltage (5V)
15	NC	Internal bond to GND
16	GND SENSE	Ground; reference potential; internal connection to the lead frame; cooling tab
17	CS	Chip select input; 5V CMOS logic level input with internal pull up; low = serial communication is enabled, high = disabled
18	CLK	Serial clock input; 5V CMOS logic level input with internal pull down; controls serial data input interface and internal shift register (f <sub>max</sub> = 2MHz)
19	DI	Serial data input; 5V CMOS logic level input with internal pull down; receives serial data from the control device; DI expects a 16-bit control word with LSB being transferred first
20	OUT6	Output 6; see pin 1
21	OUT6 SENSE	Only for testability in final test
22	OUT5 SENSE	Only for testability in final test
23	OUT5	Output 5; see pin 1
24	NC	Internal bond to GND

### 3. Functional Description

#### 3.1 Serial Interface

Data transfer starts with the falling edge of the CS signal. Data must appear at DI synchronized to CLK and is accepted on the falling edge of the CLK signal. LSB (bit 0, SRR) has to be transferred first. Execution of new input data is enabled on the rising edge of the CS signal. When CS is high, pin DO is in a tri-state condition. This output is enabled on the falling edge of CS. Output data will change their state with the rising edge of CLK and stay stable until the next rising edge of CLK appears. LSB (bit 0, TP) is transferred first.

Figure 3-1. Data Transfer Input Data Protocol

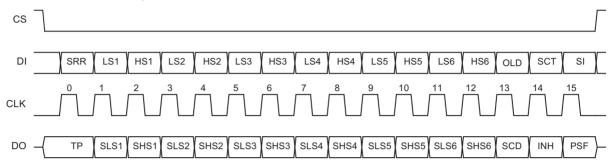


Table 3-1. Input Data Protocol

Bit	Input Register	Function
0	SRR	Status register reset (high = reset; the bits PSF, SCD and overtemperature shutdown in the output data register are set to low)
1	LS1	Controls output LS1 (high = switch output LS1 on)
2	HS1	Controls output HS1 (high = switch output HS1 on)
3	LS2	See LS1
4	HS2	See HS1
5	LS3	See LS1
6	HS3	See HS1
7	LS4	See LS1
8	HS4	See HS1
9	LS5	See LS1
10	HS5	See HS1
11	LS6	See LS1
12	HS6	See HS1
13	OLD	Open load detection (low = on)
14	SCT	Programmable time delay for short circuit (shutdown delay high/low = 12ms/1.5ms)
15	SI	Software inhibit; low = standby, high = normal operation (data transfer is not affected by standby function because the digital part is still powered)



Table 3-2. Output Data Protocol

Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or  3	Bit	Output (Status) Register	Function
1 Status LS1 Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or 3 Status LS2 Description see LS1 4 Status HS2 Description see HS1 5 Status LS3 Description see HS1 6 Status HS3 Description see HS1 7 Status LS4 Description see HS1 8 Status HS4 Description see HS1 9 Status LS5 Description see HS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition	0	TP	· · · · · · · · · · · · · · · · · · ·
2 Status HS1 Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or 3 Status LS2 Description see LS1 4 Status HS2 Description see HS1 5 Status LS3 Description see LS1 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition	1	Status LS1	· · · · · · · · · · · · · · · · · · ·
4 Status HS2 Description see HS1  5 Status LS3 Description see LS1  6 Status HS3 Description see HS1  7 Status LS4 Description see LS1  8 Status HS4 Description see HS1  9 Status LS5 Description see LS1  10 Status HS5 Description see HS1  11 Status LS6 Description see LS1  12 Status HS6 Description see HS1  13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition	2	Status HS1	
5 Status LS3 Description see LS1 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware	3	Status LS2	Description see LS1
6 Status HS3 Description see HS1  7 Status LS4 Description see LS1  8 Status HS4 Description see HS1  9 Status LS5 Description see LS1  10 Status HS5 Description see HS1  11 Status LS6 Description see LS1  12 Status HS6 Description see HS1  13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware the status HS6 of the short circuit detected is software (bit SI in input register) and hardware the status HS6 of the short circuit condition in the short circuit circuit circuit condi	4	Status HS2	Description see HS1
7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardward in the status LS6 in input register) and hardward in the status LS6 in input register in the status LS6	5	Status LS3	Description see LS1
8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware	6	Status HS3	Description see HS1
9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition 14 INIL Inhibit: this bit is controlled by software (bit SI in input register) and hardware	7	Status LS4	Description see LS1
10 Status HS5 Description see HS1  11 Status LS6 Description see LS1  12 Status HS6 Description see HS1  13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware the status of the status HS6 Description see HS1  13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition	8	Status HS4	Description see HS1
11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  14 INIL Inhibit: this bit is controlled by software (bit SI in input register) and hardware (bit SI in input register).	9	Status LS5	Description see LS1
12 Status HS6 Description see HS1  13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware.	10	Status HS5	Description see HS1
Short circuit detected: set high, when at least one output is switched off by short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware	11	Status LS6	Description see LS1
short circuit condition  Inhibit: this bit is controlled by software (bit SI in input register) and hardware	12	Status HS6	Description see HS1
	13	SCD	Short circuit detected: set high, when at least one output is switched off by a short circuit condition
initibit (piri IND). Tight – standby, low – normal operation	14	INH	Inhibit: this bit is controlled by software (bit SI in input register) and hardware inhibit (pin INH). High = standby, low = normal operation
15 PSF Power supply fail: undervoltage at pin VS detected	15	PSF	Power supply fail: undervoltage at pin VS detected

Note: Bit 0 to 15 = high: overtemperature shutdown

Table 3-3. Status of the Input Register After Power on Reset

Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
(SI)	(SCT)	(OLD)	(HS6)	(LS6)	(HS5)	(LS5)	(HS4)	(LS4)	(HS3)	(LS3)	(HS2)	(LS2)	(HS1)	(LS1)	(SRR)
Н	Н	Н	L	L	L	L	L	L	L	L	L	L	L	L	L

#### 3.2 **Power-supply Fail**

In case of undervoltage at pin VS, an internal timer is started. When during a permanent undervoltage the delay time (t<sub>dLIV</sub>) is reached, the power supply fail bit (PSF) in the output register is set and all outputs are disabled. When normal voltage is present again, the outputs are enabled immediately. The PSF bit remains high until it is reset by the SRR bit in the input reaister.

#### 3.3 **Open-load Detection**

If the open-load detection bit (OLD) is set to low, a pull-up current for each high-side switch and a pull-down current for each low-side switch is turned on (open-load detection current  $I_{HS1-6}$ ,  $I_{LS1-6}$ ). If  $V_{VS} - V_{HS1-6}$  or  $V_{LS1-6}$  is lower than the open-load detection threshold (open-load condition), the corresponding bit of the output in the output register is set to high. Switching on an output stage with OLD bit set to low disables the open load function for this output.

#### 3.4 **Overtemperature Protection**

If the junction temperature exceeds the thermal prewarning threshold, T<sub>iPW</sub> set, the temperature prewarning bit (TP) in the output register is set. When the temperature falls below the thermal prewarning threshold, T<sub>iPW</sub> reset, the bit TP is reset. The TP bit can be read without transferring a complete 16-bit data word: with CS = high to low, the state of TP appears at pin DO. After the microcontroller has read this information, CS is set high and the data transfer is interrupted without affecting the state of the input and output registers.

If the junction temperature exceeds the thermal shutdown threshold, T<sub>i switch off</sub>, the outputs are disabled and all bits in the output register are set high. The outputs can be enabled again when the temperature falls below the thermal shutdown threshold, T<sub>i switch on</sub>, and when a high has been written to the SRR bit in the input register. Thermal prewarning and shutdown threshold have hysteresis.

#### 3.5 **Short-circuit Protection**

The output currents are limited by a current regulator. Current limitation takes place when the overcurrent limitation and shutdown threshold (I<sub>HS1-6</sub>, I<sub>LS1-6</sub>) are reached. Simultaneously, an internal timer is started. The shorted output is disabled when during a permanent short the delay time (t<sub>dSd</sub>) programmed by the short-circuit timer bit (SCT) is reached. Additionally, the short-circuit detection bit (SCD) is set. If the temperature prewarning bit TP in the output register is set during a short, the shorted output is disabled after t<sub>dSd</sub> and SCD bit is set. By writing a high to the SRR bit in the input register, the SCD bit is reset and the disabled outputs are enabled.

#### 3.6 Inhibit

There are two ways to inhibit the Atmel® ATA6838C:

- Set bit SI in the input register to 0
- Switch pin INH to 0V

In both cases, all output stages are turned off but the serial interface stays active. The output stages can be activated again by bit SI = 1 (when INH = VCC) or by pin INH switched back to VCC (when SI = 1).



## 4. Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

All values refer to GND pins.

Parameters	Pin QFN24	Symbol	Value	Unit
Supply voltage	3, 4	V <sub>VS</sub>	-0.3 to +40	V
Supply voltage t < 0.5s; I <sub>S</sub> > –2A	3, 4	V <sub>VS</sub>	<b>-1</b>	V
Supply voltage difference $V_{S\_pin5(3)} - V_{S\_pin10(4)}$	3, 4	$\Delta V_{VS}$	150	mV
Logic supply voltage	14	V <sub>VCC</sub>	-0.3 to +7	V
Logic input voltage	17-19	$V_{DI,}V_{CLK,}V_{CS}$	-0.3 to V <sub>VCC</sub> +0.3	V
Logic output voltage	13	$V_{DO}$	-0.3 to V <sub>VCC</sub> +0.3	V
Input current	12, 17-19	I <sub>INH,</sub> I <sub>DI,</sub> I <sub>CLK,</sub> I <sub>CS</sub>	-10 to +10	mA
Output current	13	I <sub>DO</sub>	-10 to +10	mA
Output current	2, 5, 8, 11, 20, 23	I <sub>OUT1</sub> to I <sub>OUT6</sub>	Internally limited, see "Output Specification" in Section 7. "Electrical Characteristics" on page 9	
Output voltage	2, 5, 8, 11, 20, 23	OUT1 to OUT6	-0.3 to +40	V
Junction temperature range		T <sub>j</sub>	-40 to +150	°C
Storage temperature range		T <sub>STG</sub>	-55 to +150	°C

### 5. Thermal Resistance

Table 5-1. QFN24: Depends on the PCB-board

Parameter	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit
Junction pin		16	R <sub>thJP</sub>			< 5	K/W
Junction ambient			R <sub>thJA</sub>			35	K/W

## 6. Operating Range

Parameter	Test Conditions	Pin QFN24	Symbol	Min.	Тур.	Max.	Unit
Supply voltage		3, 4	$V_{VS}$	$V_{UV}^{(1)}$		40	V
Logic supply voltage		14	$V_{VCC}$	4.75		5.25	V
Logic input voltage		12, 17-19	$V_{\text{INH,}} V_{\text{DI,}} \\ V_{\text{CLK,}} V_{\text{CS}}$	-0.3		$V_{VCC}$	V
Serial interface clock frequency			f <sub>CLK</sub>			2	MHz
Junction temperature range			T <sub>j</sub>	-40		+150	°C

### 7. Electrical Characteristics

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; \ 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \ \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{j} < 150 ^{\circ}\text{C}; \ \text{unless otherwise specified, all values refer to GND pins.}$ 

No.	Parameters	Test Conditions	Pin QFN24	Symbol	Min.	Тур.	Max.	Unit	Type*
1	Current Consumption						'		
1.1	Total quiescent current (V <sub>S</sub> and all outputs to VS)	$\begin{array}{l} V_S = 33V \\ V_{CC} = 0V \text{ or} \\ V_{CC} = 5V, \text{ bit SI = low or} \\ V_{CC} = 5V, \text{ pin INH = low} \\ \text{Output pins to VS and} \\ \text{GND} \end{array}$	3, 4	l <sub>vs</sub>			2	μА	А
	Quiescent current	$4.75V < V_{VCC} < 5.25V$ , INH or bit SI = low	14	$I_{VCC}$			20	μA	Α
1.2	1.2 Quiescent current (VCC)	$4.75V < V_{VCC} < 5.25V$ , INH or bit SI = low, $T_J = -40^{\circ}C$	14	I <sub>VCC</sub>			30	μА	A
1.3	Supply current (VS)	V <sub>VS</sub> < 28V normal operation, all output stages off	3, 4	I <sub>VS</sub>		0.8	1.2	mA	A
1.4	Supply current (VS)	V <sub>VS</sub> < 28V normal operation, all output low stages on, no load	3, 4	I <sub>VS</sub>			10	mA	A
1.5	Supply current (VS)	V <sub>VS</sub> < 28V normal operation, all output high stages on, no load	3, 4	I <sub>VS</sub>			16	mA	A
1.6	Supply current (VCC)	4.75V < V <sub>VCC</sub> < 5.25V, normal operation	14	I <sub>VCC</sub>			150	μA	Α
1.7	Discharge current (VS)	V <sub>VS</sub> = 40V, INH = low	3, 4	I <sub>VS</sub>			5	mA	Α
2	Internal Oscillator Frequ	ency							
2.1	Frequency (time base for delay timers)			f <sub>OSC</sub>	24.3		59	kHz	Α

<sup>\*)</sup> Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.



## 7. Electrical Characteristics (Continued)

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$ 

No.	Parameters	Test Conditions	Pin QFN24	Symbol	Min.	Тур.	Max.	Unit	Type*
3	Undervoltage Detection,								
3.1	Power-on reset threshold		14	$V_{VCC}$	2.3	2.7	3.0	V	Α
3.2	Power-on reset delay time	After switching on V <sub>VCC</sub>		t <sub>dPor</sub>	30	95	160	μs	А
3.3	Undervoltage detection threshold		14	V <sub>UV</sub>	5.5		7.0	V	Α
3.4	Undervoltage detection hysteresis		14	$\Delta V_{UV}$		0.4		V	Α
3.5	Undervoltage detection delay			$t_{\text{dUV}}$	4.95		20	ms	Α
4	Thermal Prewarning and	l Shutdown							
4.1	Thermal prewarning			$T_{jPWset}$	120	145	170	°C	В
4.2	Thermal prewarning			$T_{jPWreset}$	105	130	155	°C	В
4.3	Thermal prewarning hysteresis			$T_{jPW}$		15		K	С
4.4	Thermal shutdown			T <sub>j switch off</sub>	150	175	200	°C	В
4.5	Thermal shutdown			T <sub>j switch on</sub>	135	160	185	°C	В
4.6	Thermal shutdown hysteresis			T <sub>j switch off</sub>		15		К	С
4.7	Ratio thermal shutdown/thermal prewarning			T <sub>j switch off/</sub>	1.05	1.2			С
4.8	Ratio thermal shutdown/thermal prewarning			T <sub>j switch on/</sub> T <sub>jPW reset</sub>	1.05	1.2			С
5	Output Specification (LS	1-LS6, HS1-HS6) 7.5V <	V <sub>VS</sub> < 40V						
5.1	On resistance	I <sub>Out</sub> = 600mA	2, 5, 8, 11, 20, 23	R <sub>DS OnL</sub>			1.8	Ω	Α
5.2	On resistance	I <sub>Out</sub> = -600mA	2, 5, 8, 11, 20, 23	$R_{DS\ OnH}$			1.8	Ω	Α
5.3	High-side output leakage current (total quiescent current see 1.1)	V <sub>Out1-6</sub> = 0V all output stages off	2, 5, 8, 11, 20, 23	I <sub>Out1-6</sub>	<b>–15</b>			μА	A
5.4	Low-side output leakage current (total quiescent current see 1.1)	V <sub>Out1-6</sub> = VS all output stages off	2, 5, 8, 11, 20, 23	I <sub>Out1-6</sub>			120	μА	A
5.5	Inductive shutdown energy		2, 5, 8, 11, 20, 23	W <sub>outx</sub>			15	mJ	D
5.6	Overcurrent limitation and shutdown threshold	V <sub>VS</sub> = 13V	2, 5, 8, 11, 20, 23	I <sub>LS1-6</sub>	950	1250	1710	mA	Α

<sup>\*)</sup> Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.



#### **Electrical Characteristics (Continued)** 7.

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$ 

5.7   Overcurrent limitation and shutdown threshold   20V < V <sub>VS</sub> < 40V   2,5 ,8 ,11,   20,23     1,151-6   950   2100   mA   C   C   C   C   C   C   C   C   C	No.	Parameters	Test Conditions	Pin QFN24	Symbol	Min.	Тур.	Max.	Unit	Type*
9.8. and shutdown threshold         20V < V <sub>VS</sub> < 40V	5.7		V <sub>VS</sub> = 13V		I <sub>HS1-6</sub>	-1710	-1250	-950	mA	Α
5.9.         Overcurrent limitation and shutdown threshold of and shutdown threshold of and shutdown threshold believed the state of the stat	5.8	Overcurrent limitation and shutdown threshold	20V < V <sub>VS</sub> < 40V		I <sub>LS1-6</sub>	950		2100	mA	С
5.10   Covercument shutdown delay time   Covercument   Covercum	5.9	Overcurrent limitation			I <sub>HS1-6</sub>	-2100		-950	mA	С
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	5.10		bit 14 (SCT) = low		t <sub>dSd</sub>	0.45	1.3	2.1	ms	А
3-12   detection current   (OLD) = low, output off   20, 23   lout1-6H   -1.5   -0.4   IIIA   A	5.11		bit 14 (SCT) = High		t <sub>dSd</sub>	4.8	9	15	ms	А
3.13   detection current   (OLD) = low, output off   20, 23   lout1-6L   0.45   1.75   IIIA   A	5.12				I <sub>Out1-6H</sub>	-1.5		-0.4	mA	Α
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	5.13				I <sub>Out1-6L</sub>	0.45		1.75	mA	Α
5.15 detection voltage (OLD) = low, output off 20, 23 Vout1-6H 0.6 2.5 V A   5.16 Low-side open load detection voltage (OLD) = low, output off 25, 58, 11, 20, 23 Vout1-6L 0.7 2.1 V A   5.17 High-side output switch on delay <sup>(1)</sup> $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{Load} = 30\Omega$ $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{Load} =$	5.14					1.05	1.2	2		
detection voltage $(OLD) = low, output off$ $20, 23$ $V_{Out1-6L}$ $0.7$ $2.1$ $V$ A $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$ $0.7$	5.15				V <sub>Out1-6H</sub>	0.6		2.5	V	Α
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	5.16				V <sub>Out1-6L</sub>	0.7		2.1	V	Α
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	5.17	High-side output switch on delay <sup>(1)</sup>			t <sub>don</sub>			20	μs	Α
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	5.18				t <sub>don</sub>			20	μs	Α
5.20 off delay <sup>(1)</sup> $R_{Load} = 30\Omega$ $V_{doff}$ $V_{doff}$ $V_{Load}$	5.19				t <sub>doff</sub>			20	μs	Α
5.21 corresponding high- and low-side switches $R_{Load} = 30\Omega$ $R_{Load}$	5.20	Low-side output switch off delay <sup>(1)</sup>	$V_{VS} = 13V$ $R_{Load} = 30\Omega$		$t_{doff}$			3	μs	Α
6.1 Input voltage low-level threshold  12 V <sub>IL</sub> 0.3 × V <sub>VCC</sub> V A  6.2 Input voltage high-level threshold  12 V <sub>IH</sub> 0.3 × V <sub>VCC</sub> V A  13 V <sub>IH</sub> 0.3 × V <sub>VCC</sub> V A	5.21	corresponding high- and	$V_{VS} = 13V$ $R_{Load} = 30\Omega$		$t_{don} - t_{doff}$	0.7			μs	A
6.1 threshold  6.2 Input voltage high-level threshold  12 V <sub>IL</sub> V <sub>VCC</sub> V A  12 V <sub>IL</sub> V <sub>VCC</sub> 12 V <sub>IH</sub> 13 V <sub>IH</sub> 14 V <sub>VCC</sub> V A  15 AV 100 700 mV A	6	Inhibit Input								
threshold V <sub>IH</sub> V <sub>VCC</sub> V A  Hysteresis of input 12 AV 100 700 mV A	6.1			12	V <sub>IL</sub>				V	А
	6.2			12	V <sub>IH</sub>				V	А
Totago	6.3	Hysteresis of input voltage		12	$\Delta V_{I}$	100		700	mV	А
6.4 Pull-down current $V_{INH} = V_{VCC}$ $I_{PD}$ 10 80 $\mu$ A A	6.4	Pull-down current	V <sub>INH</sub> = V <sub>VCC</sub>		I <sub>PD</sub>	10		80	μA	Α

<sup>\*)</sup> Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% Note: of final level. Device not in standby for t > 1ms.



## 7. Electrical Characteristics (Continued)

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$ 

No.	Parameters	Test Conditions	Pin QFN24	Symbol	Min.	Тур.	Max.	Unit	Type*
7	Serial Interface: Logic In	puts DI, CLK, CS							
7.1	Input voltage low-level threshold		17-19	$V_{\rm IL}$	$0.3 \times V_{VCC}$			V	Α
7.2	Input voltage high-level threshold		17-19	V <sub>IH</sub>			0.7 × V <sub>VCC</sub>	V	Α
7.3	Hysteresis of input voltage		17-19	$\Delta V_{I}$	50		500	mV	Α
7.4	Pull-down current pin DI, CLK	$V_{DI}$ , $V_{CLK} = V_{VCC}$	18, 19	I <sub>PDSI</sub>	2		50	μA	Α
7.5	Pull-up current pin CS	V <sub>CS</sub> = 0V	17	I <sub>PUSI</sub>	-50		-2	μA	Α
8	Serial Interface: Logic O	utput DO							
8.1	Output voltage low level	I <sub>OL</sub> = 3mA	13	$V_{DOL}$			0.5	V	Α
8.2	Output voltage high level	I <sub>OL</sub> = -1mA	13	$V_{DOH}$	V <sub>VCC</sub> – 0.7V			V	Α
8.3	Leakage current (tri-state)	$V_{CS} = V_{VCC}$ , $0V < V_{DO} < V_{VCC}$	13	I <sub>DO</sub>	-10		10	μА	Α

<sup>\*)</sup> Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

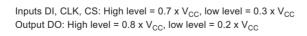
Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.

## 8. Serial Interface: Timing

Parameters	Test Conditions	QFN24	Number in Timing Diagram (Figure 8-1 on page 13)	Symbol	Min.	Тур.	Max.	Unit
DO enable after CS falling edge	C <sub>DO</sub> = 100pF	13	1	t <sub>ENDO</sub>			200	ns
DO disable after CS rising edge	C <sub>DO</sub> = 100pF	13	2	t <sub>DISDO</sub>			200	ns
DO fall time	C <sub>DO</sub> = 100pF	13	-	t <sub>DOf</sub>			100	ns
DO rise time	C <sub>DO</sub> = 100pF	13	-	t <sub>DOr</sub>			100	ns
DO valid time	C <sub>DO</sub> = 100pF	13	10	t <sub>DOVal</sub>			200	ns
CS setup time		17	4	t <sub>CSSethl</sub>	225			ns
CS setup time		17	8	t <sub>CSSetIh</sub>	225			ns
CS high time	Input register bit 14 (SCT) = high	17	9	t <sub>CSh</sub>	17			ms
CS high time	Input register bit 14 (SCT) = low	17	9	t <sub>CSh</sub>	2.1			ms
CLK high time		18	5	t <sub>CLKh</sub>	225			ns
CLK low time		18	6	t <sub>CLKI</sub>	225			ns
CLK period time		18	-	t <sub>CLKp</sub>	500			ns
CLK setup time		18	7	t <sub>CLKSethl</sub>	225			ns
CLK setup time		18	3	t <sub>CLKSetlh</sub>	225			ns
DI setup time		19	11	t <sub>Diset</sub>	40			ns
DI hold time		19	12	t <sub>DIHold</sub>	40			ns

CS DO CS CLK (6) DI (11) CLK (12) DO

Figure 8-1. Serial Interface Timing Diagram with Item Numbers





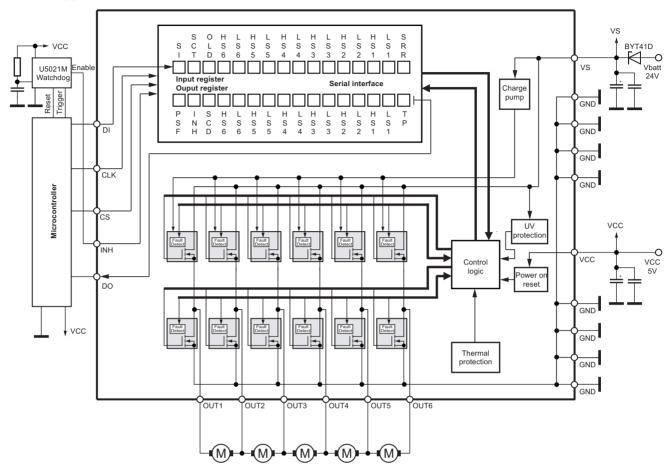
# 9. Noise and Surge Immunity

Parameters	Test Conditions	Value
Conducted interferences	ISO 7637-1	Level 4 <sup>(1)</sup>
Interference suppression	VDE 0879 Part 2	Level 5
ESD (Human Body Model)	ESD S 5.1	4kV
CDM (Charge Device Model)	ESD STM5.3	750V for corner pins (SO package only) 500V all other pins
MM (Machine Model)	ESD STM5.2	200V

Note: 1. Test pulse 5: V<sub>vbmax</sub> = 40V

### 10. Application Circuit

Figure 10-1. Application Circuit



### 10.1 Application Notes

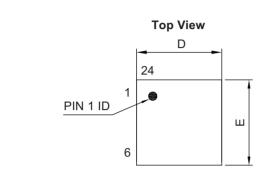
- Connect the blocking capacitors at V<sub>CC</sub> and V<sub>S</sub> as close as possible to the power supply and GND pins.
- Recommended value for capacitors at V<sub>S</sub>:
   Electrolytic capacitor C > 22µF in parallel with a ceramic capacitor C = 100nF.
   Value for electrolytic capacitor depends on external loads, conducted interferences and reverse-conducting current IHSX (see Section 4. "Absolute Maximum Ratings" on page 8).
- Recommended value for capacitors at VCC:
   Electrolytic capacitor C > 10µF in parallel with a ceramic capacitor C = 100nF.
- To reduce thermal resistance, place cooling areas on the PCB as close as possible to GND pins and to the die paddle in QFN24.
- The sense pins OUTx SENSE can either be left open or can be connected to the adjacent OUTx pin. Never use the sense pins OUTx SENSE as power outputs.

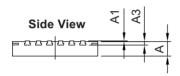


# 11. Ordering Information

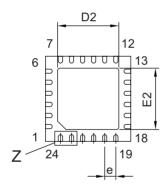
Extended Type Number	Package	Remarks
ATA6838C-PXQW-1	QFN24	Pb-free, 6k, taped and reeled

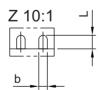
## 12. Package Information





### **Bottom View**





	СОММО	ON DIME	NSIONS	
	(Unit o	f Measure	e = mm)	
Symbol	MIN	NOM	MAX	NOTE
Α	0.8	0.85	0.9	
A1	0.0	0.035	0.05	
A3	0.16	0.21	0.26	
D	4.9	5	5.1	
D2	3.5	3.6	3.7	
E	4.9	5	5.1	·

3.6

0.4

0.25

0.65

3.7

0.45

0.3

E2

L

b

3.5

0.35

0.2

technical drawings according to DIN specifications

Dimensions in mm

10/18/13

Atmel	Package Drawing Contact: packagedrawings@atmel.com

TITLE	
Package: VQFN_5x5_24 Exposed pad 3.6x3.6	L

GPC	DRAWING NO.	REV.
	6.543-5132.02-4	1

# 13. Revision History

Please note that the following page numbers referred to in this section refer to the specific revision mentioned, not to this document.

Revision No.	History
9237G-AUTO-02/15	Section 11 "Ordering Information" on page 16 updated
9237G-AUTO-02/15	Section 12 "Package Information" on page 16 updated
9237F-AUTO-05/12	Set datasheet from "Preliminary" to "Standard"
9237E-AUTO-03/12	Section 3.5 "Short-circuit Protection" on page 7 updated
9237D-AUTO-12/11	• Section 7 "Electrical Characteristics" numbers 3.5, 5.10, 5.13 and 5.16 on page 10 to 11 updated
9237C-AUTO-10/11	Section 10.1 "Application Notes" on page 15 updated















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